





Atty. Docket No. AMAT/3976.P1/CMP/CMP/RKK

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application

Assistant Commissioner of Patents and Trademarks

Washington, D.C. 20231

Inventor(s): Re:

RAMIN EMAMI; SHIJIAN LI; SEN-HOU KO; FRED C. REDEKER and

MADHAVI CHANDRACHOOD

Title:

PLANARIZED COPPER CLEANING FOR REDUCED DEFECTS

Transmitted herewith is	the pa	atent applicati	on identified	l above,	including
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\underline{X} Specification, claims and abstract,	totaling		pages
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- Drawings totaling 2 pages, X Formal Informal. \mathbf{X}
- X Executed Declaration and Power of Attorney.
- Information Disclosure Statement w/ Form 1449 and References.
- Assignment of the invention to Applied Materials, Inc.

Assignment Recordation Cover Sheet

FEE CALCUL	ATION				
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Fotal Claims	60	-20=	40	x \$18.00	\$ 720.00
Independent Claims	2	-3=	0	x \$80.00	\$ 0.00
Basic Filing Fee \$710.00					
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TOTAL FEES					\$1430.00

- The Commissioner is hereby authorized to charge \$1430.00 to Deposit Account No. 50-1074/3976.P1/CMP/CMP/RKK. X
- The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to X Deposit Account No. 50-1074/3976.P1/CMP/CMP/RKK. A duplicate copy of this transmittal is enclosed.

X Please address all future correspondence to:

PATENT COUNSEL

APPLIED MATERIALS, INC.

Legal Affairs Department

P.O.BOX 450A

Santa Clara, CA. 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Robert W. Mulcahy Registration No. 25,436

Respectfully_submitted

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UNITED STATES PATENT APPLICATION FOR:

PLANARIZED COPPER CLEANING FOR REDUCED DEFECTS

INVENTORS:

RAMIN EMAMI
SHIJIAN LI
SEN-HOU KO
FRED C. REDEKER
MADHAVI CHANDRACHOOD

Certification Under 37 CFR 1.10

I hereby certify that this New Application and the documents referred to as enclosed therein are being deposited with the United States Postal Service on $\frac{1}{2}$, 2000, in an envelope marked as "Express Mail United States Postal Service", Mailing Label No. EL684622136US, addressed to: Assistant Commissioner for Patents, Box PATENT APPLICATION, Washington, D.C. 20231.

Name

Signature

Date of Signature